Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

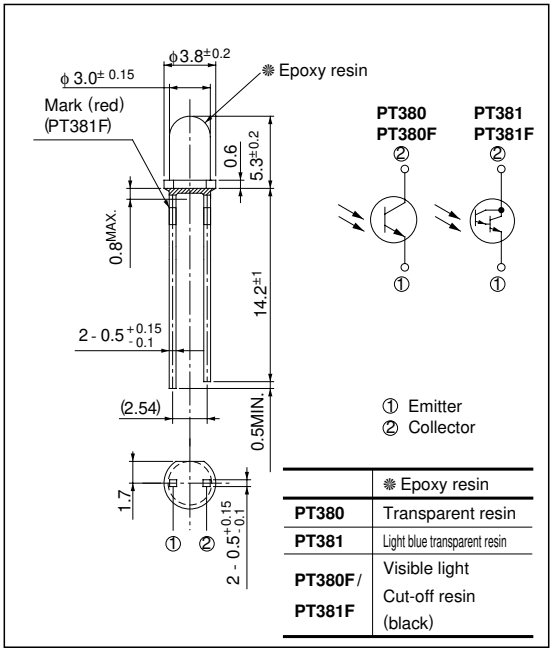
PT380/PT380F PT381/PT381F

High Sensitivity, ϕ3mm Resin Mold Type Phototransistor

■ Features

1. High sensitivity
   (I_C : MIN.160μA at E_V = 100lx, **PT380**)
   (I_C : MIN.120μA at E_V = 2lx, **PT381**)
2. Compact ϕ3mm resin mold package
3. Intermediate acceptance (Δθ : TYP. ± 20°)
4. Visible light cut-off type : **PT380F / PT381F**

■ Outline Dimensions (Unit : mm)



	✵ Epoxy resin
PT380	Transparent resin
PT381	Light blue transparent resin
PT380F / PT381F	Visible light Cut-off resin (black)

■ Model Line-ups

	Single photo-transistor output	Darlington photo-transistor output
No visible light cut-off filter	**PT380**	**PT381**
Built-in visible light cut-off filter	**PT380F**	**PT381F**

■ Applications

1. Floppy disk drives
2. Optoelectronic switches
3. Infrared applied systems

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Rating	Unit
Collector-emitter voltage	V_{CEO}	35	V
Emitter-collector voltage	V_{ECO}	6	V
Collector current	I_C	20	mA
Collector power dissipation	P_C	50	mW
Operating temperature	T_{opr}	- 25 to + 85	°C
Storage temperature	T_{stg}	- 40 to + 85	°C
*1 Soldering temperature	T_{sol}	260	°C

*1 For 3 seconds at the position of 1.4mm from the bottom face of resin package

■ Electro-optical Characteristics

(Ta = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*2Collector current	PT380	I_C	E_V = 100lx, V_{CE} = 5V	0.16	-	1.17	mA
	PT380F			0.095	-	0.90	
	PT381		E_V = 2lx, V_{CE} = 10V	0.12	-	1.5	
	PT381F			0.07	-	1.08	
Collector dark current	PT380 / PT380F	I_{CEO}	E_e = 0, V_{CE} = 20V	-	-	0.1	μA
	PT381 / PT381F		E_e = 0, V_{CE} = 10V	-	-	1.0	
*2Collector-emitter saturation voltage	PT380 / PT380F	$V_{CE(sat)}$	E_e = 10mW/cm², I_C = 0.5mA	-	0.2	0.4	V
	PT381 / PT381F		E_e = 1mW/cm², I_C = 2.5mA	-	-	1.0	
Collector-emitter breakdown voltage		BV_{CEO}	I_C = 0.1mA, E_e = 0	35	-	-	V
Emitter-Collector breakdown voltage		BV_{ECO}	I_C = 0.01mA, E_e = 0	6	-	-	V
Peak sensitivity wavelength	PT380 / PT381	λ_P	-	-	800	-	nm
	PT380F / PT381F			-	860	-	
Response time: Rise time	PT380 / PT380F	t_r	V_{CE} = 20V, I_C = 1mA, R_L = 1kΩ	-	10	40	μs
	PT381 / PT381F		V_{CE} = 2V, I_C = 10mA, R_L = 100Ω	-	100	400	
Response time: Fall time	PT380 / PT380F	t_f	V_{CE} = 20V, I_C = 1mA, R_L = 1kΩ	-	8	35	
	PT381 / PT381F		V_{CE} = 2V, I_C = 10mA, R_L = 100Ω	-	100	400	
Half intensity angle		Δθ	-	-	±20	-	°

*2 E_V, E_e : Illuminance, irradiance by CIE standard light source A (tungsten lamp)

Fig. 1 Collector Power Dissipation vs. Ambient Temperature

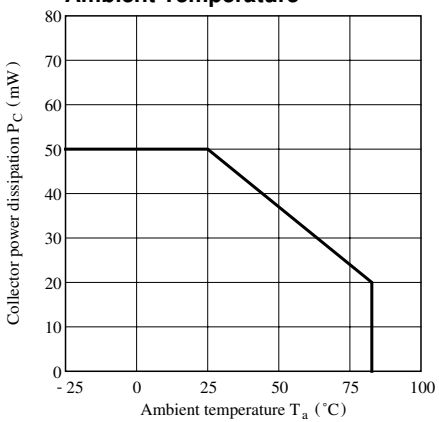


Fig. 2-a Collector Dark Current vs. Ambient Temperature (PT380/PT380F)

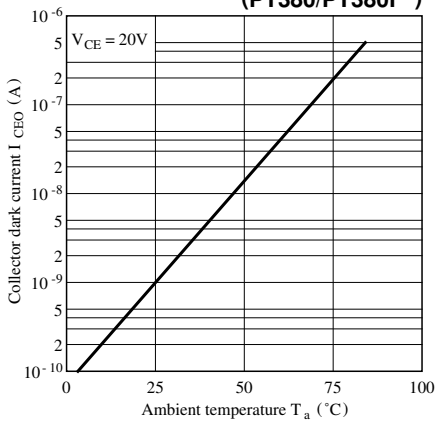


Fig. 2-b Collector Dark Current vs. Ambient Temperature (PT381/381F)

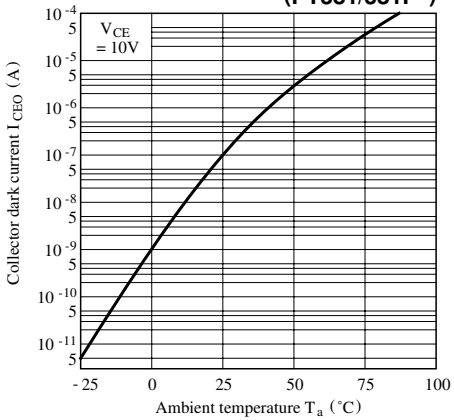


Fig. 3-a Relative Collector Current vs. Ambient Temperature (PT380/PT380F)

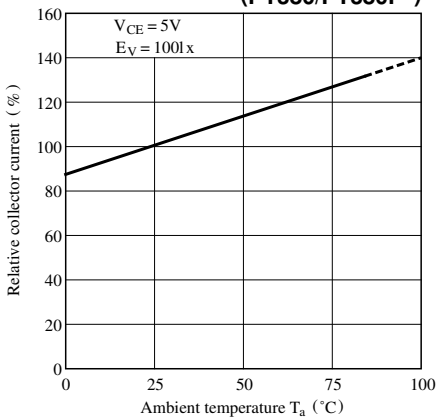


Fig. 3-b Relative Collector Current vs. Ambient Temperature (PT381/PT381F)

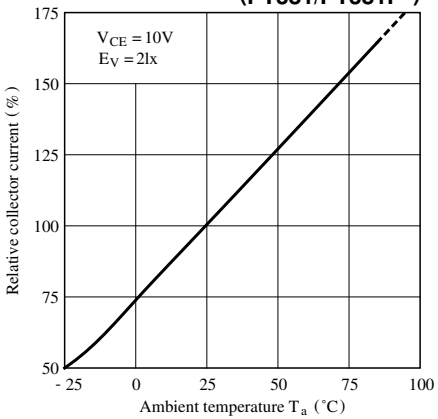


Fig. 4-a Collector Current vs. Irradiance (PT380/380F)

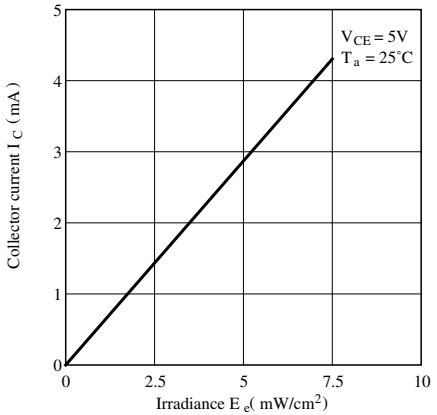


Fig. 4-b Collector Current vs. Irradiance (PT381/PT381F)

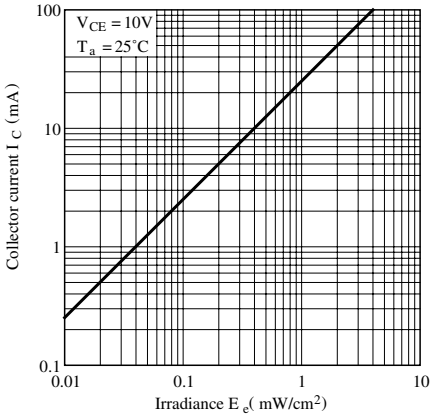


Fig. 5-a Collector Current vs. Collector-emitter Voltage (PT380/380F)

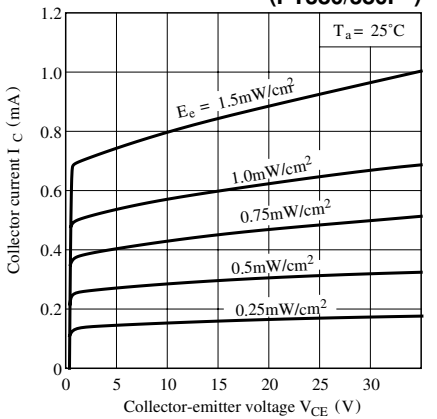


Fig. 5-b Collector Current vs. Collector-emitter Voltage (PT381/381F)

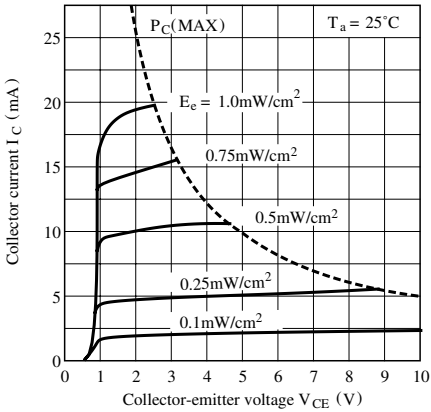


Fig. 6 Spectral Sensitivity

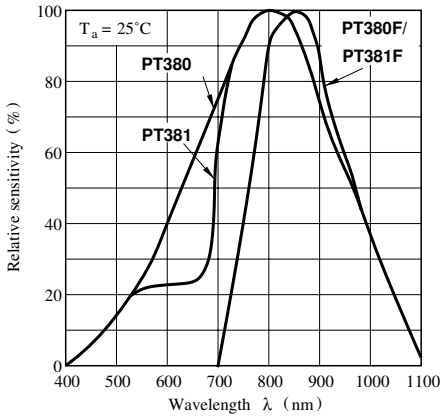
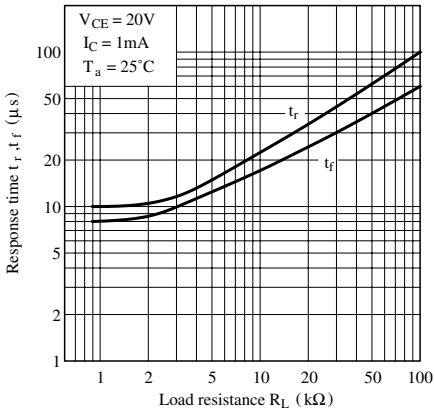


Fig. 7-a Response Time vs. Load Resistance (PT380/PT380F)



Test Circuit for Response Time

(PT380/PT380F)

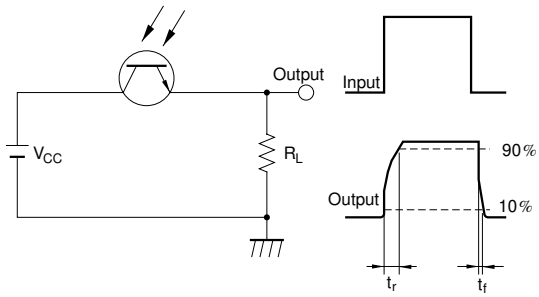
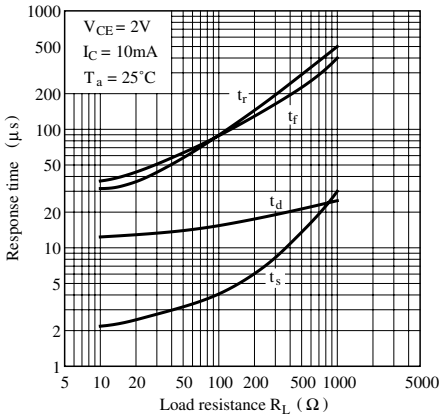


Fig. 7-b Response Time vs. Load Resistance (PT381/381F)



Test Circuit for Response Time

(PT381/PT381F)

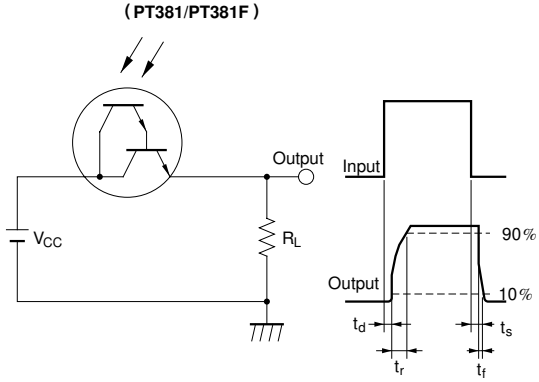


Fig. 8-a Collector-emitter Saturation Voltage vs. Irradiance (PT380/380F)

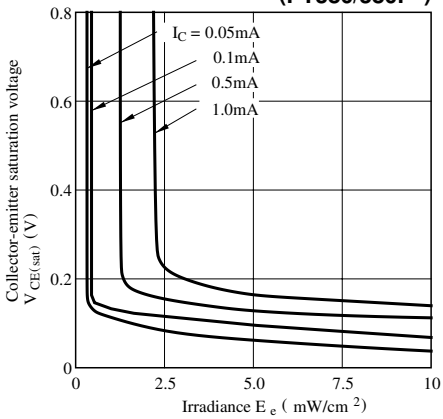


Fig. 8-b Collector-emitter Saturation Voltage vs. Irradiance (PT381/381F)

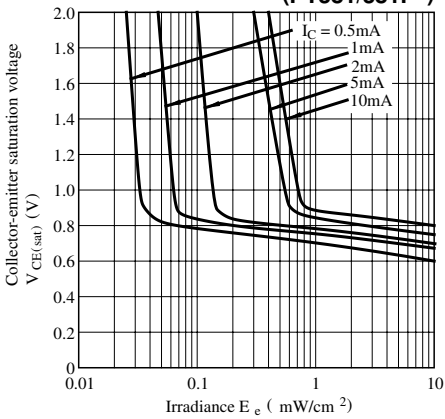


Fig. 9 Sensitivity Diagram (T_a= 25°C)

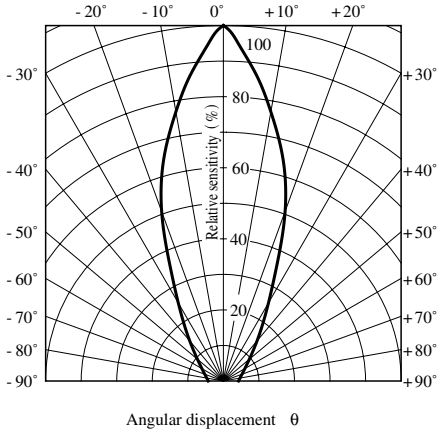
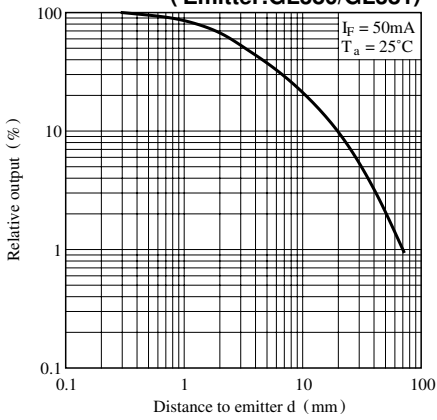


Fig.10 Relative Collector Current vs. Distance to Emitter (Emitter:GL380/GL381)



Please refer to the chapter " Precautions for Use."

NOTICE

- The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:

(i) The devices in this publication are designed for use in general electronic equipment designs such as:
- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

- Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.
- If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Control Law of Japan, it is necessary to obtain approval to export such SHARP devices.
-
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.